



### May 23, 2005

# Integrated Buffers with V<sub>COM</sub>

The EL5524, EL5624, EL5724, and EL5824 integrate a number of gamma reference buffers with a single  $V_{COM}$ amplifier. The EL5524 contains 4 gamma buffers, the EL5624 contains 6, the EL5724 contains 8, and the EL5824 contains 10. Each gamma buffer has a bandwidth of 12MHz and features a slew rate of 15V/µs. The output current is rated at 30mA continuous, 140mA peak.

Data Sheet

The V<sub>COM</sub> amplifiers are rated for 60mA continuous output current and 200mA peak. They also feature higher slew rate and bandwidth for use in error cancellation circuits.

The EL5524 is available in the 14-pin HTSSOP package, the EL5624 in the 20-pin HTSSOP package, the EL5724 in the 24-pin HTSSOP package, and the EL5824 in the 28-pin HTSSOP package. All are specified for operation over the -40°C to +85°C temperature range.

### Features

- 4 x gamma buffers (EL5524)
- 6 x gamma buffers (EL5624)
- 8 x gamma buffers (EL5724)
- 10 x gamma buffers (EL5824)
- Single V<sub>COM</sub> amplifier
- 140mA max V<sub>COM</sub> output current
- Low power
  - 5.4mA (EL5524)
  - 6.8mA (EL5624)
  - 8.3mA (EL5724)
  - 9.5mA (EL5824)
- Pb-Free plus Anneal available (RoHS compliant)

### Applications

- · TFT-LCD displays
- · Flat panel monitors
- Notebook displays
- LCD-TVs

### **Ordering Information** (Continued)

| PART NUMBER                  | PACKAGE                    | TAPE &<br>REEL | PKG. DWG. # |
|------------------------------|----------------------------|----------------|-------------|
| EL5724IRE-T13                | 24-Pin HTSSOP              | 13"            | MDP0048     |
| EL5724IREZ<br>(See Note)     | 24-Pin HTSSOP<br>(Pb-free) | -              | MDP0048     |
| EL5724IREZ-T7<br>(See Note)  | 24-Pin HTSSOP<br>(Pb-free) | 7"             | MDP0048     |
| EL5724IREZ-T13<br>(See Note) | 24-Pin HTSSOP<br>(Pb-free) | 13"            | MDP0048     |
| EL5824IRE                    | 28-Pin HTSSOP              | -              | MDP0048     |
| EL5824IRE-T7                 | 28-Pin HTSSOP              | 7"             | MDP0048     |
| EL5824IRE-T13                | 28-Pin HTSSOP              | 13"            | MDP0048     |
| EL5824IREZ<br>(See Note)     | 28-Pin HTSSOP<br>(Pb-free) | -              | MDP0048     |
| EL5824IREZ-T7<br>(See Note)  | 28-Pin HTSSOP<br>(Pb-free) | 7"             | MDP0048     |
| EL5824IREZ-T13<br>(See Note) | 28-Pin HTSSOP<br>(Pb-free) | 13"            | MDP0048     |

NOTE: Intersil Pb-free products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

## Ordering Information

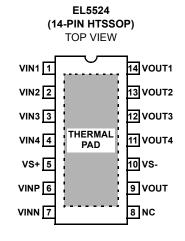
| PART NUMBER                  | PACKAGE                    | TAPE &<br>REEL | PKG. DWG. # |  |  |
|------------------------------|----------------------------|----------------|-------------|--|--|
| EL5524IRE                    | 14-Pin HTSSOP              | -              | MDP0048     |  |  |
| EL5524IRE-T7                 | 14-Pin HTSSOP              | 7"             | MDP0048     |  |  |
| EL5524IRE-T13                | 14-Pin HTSSOP              | 13"            | MDP0048     |  |  |
| EL5524IREZ<br>(See Note)     | 14-Pin HTSSOP<br>(Pb-free) | -              | MDP0048     |  |  |
| EL5524IREZ-T7<br>(See Note)  | 14-Pin HTSSOP<br>(Pb-free) | 7"             | MDP0048     |  |  |
| EL5524IREZ-T13<br>(See Note) | 14-Pin HTSSOP<br>(Pb-free) | 13"            | MDP0048     |  |  |
| EL5624IRE                    | 20-Pin HTSSOP              | -              | MDP0048     |  |  |
| EL5624IRE-T7                 | 20-Pin HTSSOP              | 7"             | MDP0048     |  |  |
| EL5624IRE-T13                | 20-Pin HTSSOP              | 13"            | MDP0048     |  |  |
| EL5624IREZ<br>(See Note)     | 20-Pin HTSSOP<br>(Pb-free) | -              | MDP0048     |  |  |
| EL5624IREZ-T7<br>(See Note)  | 20-Pin HTSSOP<br>(Pb-free) | 7"             | MDP0048     |  |  |
| EL5624IREZ-T13<br>(See Note) | 20-Pin HTSSOP<br>(Pb-free) | 13"            | MDP0048     |  |  |
| EL5724IRE                    | 24-Pin HTSSOP              | -              | MDP0048     |  |  |
| EL5724IRE-T7                 | 24-Pin HTSSOP              | 7"             | MDP0048     |  |  |

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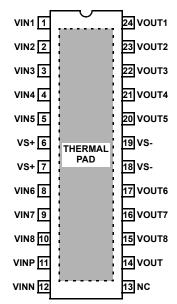
CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. 1-888-INTERSIL or 1-888-352-6832 | Intersil (and design) is a registered trademark of Intersil Americas Inc. Copyright Intersil Americas Inc. 2003, 2005. All Rights Reserved

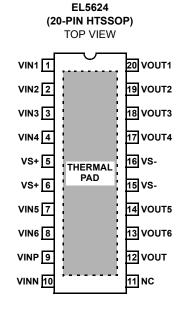
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### Pinouts

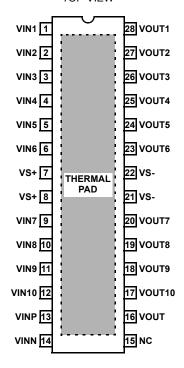








EL5824 (28-PIN HTSSOP) TOP VIEW



### Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

| Supply Voltage between V <sub>S</sub> + and V <sub>S</sub> | +18V  |
|--|---|
| Input Voltage  | V <sub>S</sub> 0.5V, V <sub>S</sub> + +0.5V |
| Maximum Continuous Output Current (Buffer)                 |   |
| Maximum Continuous Output Current (V <sub>COM</sub> )      | 60mA  |

| Power Dissipation       | See Curves     |
|-------------------------|----------------|
| Maximum Die Temperature | +125°C         |
| Storage Temperature     | 65°C to +150°C |
| Operating Conditions    | 40°C to +85°C  |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE: All parameters having Min/Max specifications are guaranteed. Typ values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$ 

### $\label{eq:constraint} \textbf{Electrical Specifications} \quad V_{S} \texttt{+} \texttt{=} \texttt{+}15 \texttt{V}, \ V_{S} \texttt{-} \texttt{=} 0, \ \texttt{R}_{L} \texttt{=} 10 \texttt{k}\Omega, \ \texttt{C}_{L} \texttt{=} 10 \texttt{pF} \text{ to } 0\texttt{V}, \ \texttt{Gain of } V_{COM} \texttt{=} 1, \ \texttt{RLV}_{CM} \texttt{=} 1\texttt{k}\Omega \text{ and } \texttt{RLV}_{CM} \texttt{=} 1\texttt{k}\Omega \texttt{and} \texttt{RLV}_{CM} \texttt{and} \texttt{RLV}_{$

| T <sub>A</sub> = 25°C Unless Otherwise Specified |  |
|--|--|
|--|--|

| PARAMETER         | DESCRIPTION                              | CONDITIONS  | MIN   | TYP   | MAX   | UNIT  |
|-------------------|--|---|-------|-------|-------|-------|
| INPUT CHARAG      | CTERISTICS (REFERENCE BUFFER             | RS)   |       |       |       |       |
| V <sub>OS</sub>   | Input Offset Voltage                     | V <sub>CM</sub> = 0V  |       | 2     | 14    | mV    |
| TCV <sub>OS</sub> | Average Offset Voltage Drift             | (Note 1)  |       | 5     |       | µV/∘C |
| IB                | Input Bias Current                       | V <sub>CM</sub> = 0V  |       | 2     | 50    | nA    |
| R <sub>IN</sub>   | Input Impedance                          |   |       | 1     |       | GΩ    |
| C <sub>IN</sub>   | Input Capacitance                        |   |       | 1.35  |       | pF    |
| A <sub>V</sub>    | Voltage Gain                             | $1V \le V_{OUT} \le 14V$                                      | 0.992 |       | 1.008 | V/V   |
| INPUT CHARAG      | CTERISTICS (V <sub>COM</sub> AMPLIFIER)  |   |       |       |       |       |
| V <sub>OS</sub>   | Input Offset Voltage                     | V <sub>CM</sub> = 7.5V  |       | 1     | 15    | mV    |
| TCV <sub>OS</sub> | Average Offset Voltage Drift             | (Note 1)  |       | 5     |       | µV/∘C |
| IB                | Input Bias Current                       | V <sub>CM</sub> = 7.5V  |       | 2     | 50    | nA    |
| R <sub>IN</sub>   | Input Impedance                          |   |       | 1     |       | GΩ    |
| C <sub>IN</sub>   | Input Capacitance                        |   |       | 1.35  |       | pF    |
| V <sub>REG</sub>  | Load Regulation                          | V <sub>COM</sub> = 1.5V, -60mA < I <sub>L</sub> < 60mA        | -20   |       | +20   | mV    |
| A <sub>VOL</sub>  | Open Loop Gain                           | $R_L = 1k\Omega$  | 55    | 75    |       | dB    |
| CMRR              | Common Rejection Ratio                   |   | 45    | 70    |       | dB    |
| OUTPUT CHAR       | ACTERISTICS (REFERENCE BUFF              | ERS)  |       |       |       |       |
| V <sub>OL</sub>   | Output Swing Low                         | I <sub>L</sub> = 7.5mA  |       | 50    | 150   | mV    |
| V <sub>OH</sub>   | Output Swing High                        | I <sub>L</sub> = 7.5mA  | 14.85 | 14.95 |       | V     |
| I <sub>SC</sub>   | Short Circuit Current                    | R <sub>L</sub> = 10Ω  | ±120  | ±140  |       | mA    |
| OUTPUT CHAR       | ACTERISTICS (V <sub>COM</sub> AMPLIFIER) |   |       |       |       |       |
| V <sub>OL</sub>   | Output Swing Low                         | I <sub>L</sub> = -7.5mA                                       |       | 50    | 150   | mV    |
| V <sub>OH</sub>   | Output Swing High                        | I <sub>L</sub> = +7.5mA                                       | 14.85 | 14.95 |       | V     |
| I <sub>SC</sub>   | Short Circuit Current                    | R <sub>L</sub> = 10Ω  | ±180  | ±200  |       | mA    |
| POWER SUPPL       | Y PERFORMANCE                            |   |       |       |       |       |
| PSRR              | Power Supply Rejection Ratio             | Reference buffer $\mathrm{V}_{\mathrm{S}}$ from 4.5V to 15.5V | 55    | 80    |       | dB    |
|                   |  | $V_{\mbox{COM}}$ buffer, $V_{\mbox{S}}$ from 4.5V to 15.5V    | 55    | 80    |       | dB    |
| I <sub>S</sub>    | Total Supply Current                     | EL5524 (no load)  |       | 5.4   | 7     | mA    |
|                   |  | EL5624 (no load)  |       | 6.8   | 8.5   | mA    |
|                   |  | EL5724 (no load)  |       | 8.3   | 11    | mA    |
|                   |  | EL5824 (no load)  |       | 9.5   | 12.5  | mA    |
|                   |  |   |       |       |       |       |

#### 

| PARAMETER   | DESCRIPTION                            | TION CONDITIONS                                 |       | TYP | MAX | UNIT |
|-------------|--|---|-------|-----|-----|------|
| DYNAMIC PER | FORMANCE (BUFFER AMPLIFIER             | S)  | 4     |     | 1   |      |
| SR          | Slew Rate (Note 2)                     | -4V $\leq V_{OUT} \leq$ 4V, 20% to 80%          | 7     | 15  |     | V/µs |
| ts          | Settling to +0.1% ( $A_V$ = +1)        | (A <sub>V</sub> = +1), V <sub>O</sub> = 2V step |       | 250 |     | ns   |
| BW          | -3dB Bandwidth                         | $R_L = 10k\Omega$ , $C_L = 10pF$                |       | 12  |     | MHz  |
| GBWP        | Gain-Bandwidth Product                 | $R_L = 10k\Omega$ , $C_L = 10pF$                | 8     |     |     | MHz  |
| PM          | Phase Margin                           | $R_{L}$ = 10kΩ, $C_{L}$ = 10pF                  | 50    |     |     | 0    |
| CS          | Channel Separation                     | f = 5MHz  |       | 75  |     | dB   |
| DYNAMIC PER | FORMANCE (V <sub>COM</sub> AMPLIFIERS) |   | H     |     | 1   |      |
| SR          | Slew Rate (Note 2)                     | -4V $\leq V_{OUT} \leq$ 4V, 20% to 80%          | 65    | 90  |     | V/µs |
| ts          | Settling to +0.1% ( $A_V$ = +1)        | (A <sub>V</sub> = +1), V <sub>O</sub> = 6V step |       | 150 |     | ns   |
| BW          | -3dB Bandwidth                         | $R_L = 1k\Omega$ , $C_L = 2pF$                  | 35 M  |     | MHz |      |
| GBWP        | Gain-Bandwidth Product                 | $R_L = 1k\Omega$ , $C_L = 2pF$                  | 20 MH |     | MHz |      |
| PM          | Phase Margin                           | $R_L = 1k\Omega$ , $C_L = 2pF$                  |       | 50  |     | 0    |

NOTES:

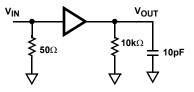
1. Measured over operating temperature range

2. Slew rate is measured on rising and falling edges

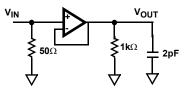
# **Pin Descriptions**

| EL5524 | EL5624 | EL5724 | EL5824 | PIN NAME | PIN FUNCTION                      |
|--------|--------|--------|--------|----------|-----------------------------------|
| 1      | 1      | 1      | 1      | VIN1     | Input                             |
| 2      | 2      | 2      | 2      | VIN2     | Input                             |
| 3      | 3      | 3      | 3      | VIN3     | Input                             |
| 4      | 4      | 4      | 4      | VIN4     | Input                             |
| 5      | 5, 6   | 6, 7   | 7, 8   | VS+      | Positive supply                   |
| 6      | 9      | 11     | 13     | VINP     | Positive input - V <sub>COM</sub> |
| 7      | 10     | 12     | 14     | VINN     | Negative input - V <sub>COM</sub> |
| 8      | 11     | 13     | 15     | NC       | Not connected                     |
| 9      | 12     | 14     | 16     | VOUT     | Output for V <sub>COM</sub>       |
| 10     | 15, 16 | 18, 19 | 21, 22 | VS-      | Negative supply                   |
| 11     | 17     | 21     | 25     | VOUT4    | Output                            |
| 12     | 18     | 22     | 26     | VOUT3    | Output                            |
| 13     | 19     | 23     | 27     | VOUT2    | Output                            |
| 14     | 20     | 24     | 28     | VOUT1    | Output                            |
|        | 7      | 5      | 5      | VIN5     | Input                             |
|        | 8      | 8      | 6      | VIN6     | Input                             |
|        | 14     | 20     | 24     | VOUT5    | Output                            |
|        | 13     | 17     | 23     | VOUT6    | Output                            |
|        |        | 9      | 9      | VIN7     | Input                             |
|        |        | 10     | 10     | VIN8     | Input                             |
|        |        | 16     | 20     | VOUT7    | Output                            |
|        |        | 15     | 19     | VOUT8    | Output                            |
|        |        |        | 11     | VIN9     | Input                             |
|        |        |        | 12     | VIN10    | Input                             |
|        |        |        | 18     | VOUT9    | Output                            |
|        |        |        | 17     | VONT10   | Output                            |

# Test Circuits



FOR BUFFERS



FOR V<sub>COM</sub>

FIGURE 5. INPUT NOISE SPECIAL DENSITY vs FREQUENCY (BUFFER)

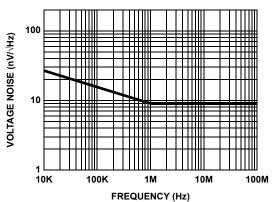
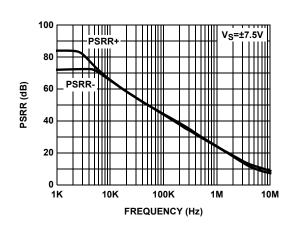


FIGURE 3. PSRR vs FREQUENCY (BUFFER)



(BUFFER)

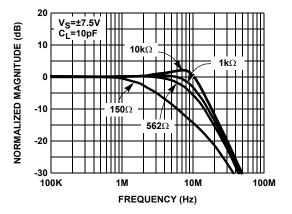


FIGURE 1. FREQUENCY RESPONSE FOR VARIOUS RL

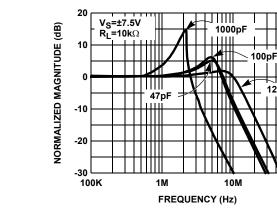
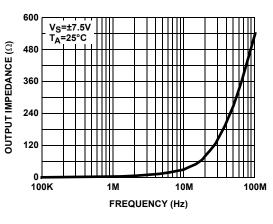


FIGURE 2. FREQUENCY RESPONSE FOR VARIOUS CL (BUFFER)



12p

100M

# **Typical Performance Curves**

FIGURE 6. OVERSHOOT vs LOAD CAPACITANCE (BUFFER)

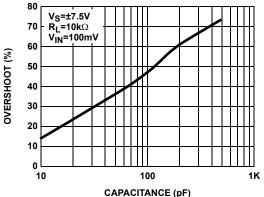


FIGURE 4. OUTPUT IMPEDANCE vs FREQUENCY (BUFFER)

### Typical Performance Curves (Continued)

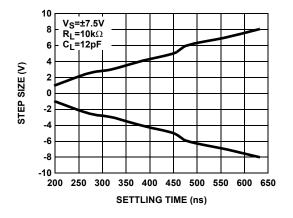


FIGURE 7. SETTLING TIME vs STEP SIZE (BUFFER)

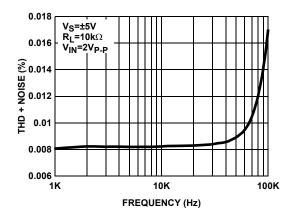


FIGURE 8. TOTAL HARMONIC DISTORTION + NOISE vs FREQUENCY (BUFFER)

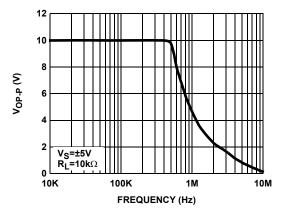


FIGURE 9. OUTPUT SWING vs FREQUENCY (BUFFER)

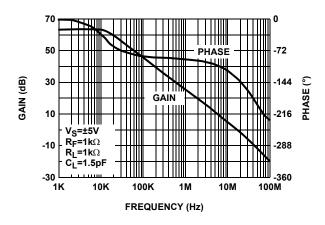


FIGURE 11. OPEN LOOP GAIN AND PHASE vs FREQUENCY

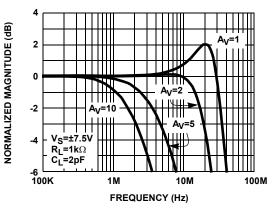


FIGURE 10. FREQUENCY RESPONSE (VCOM)

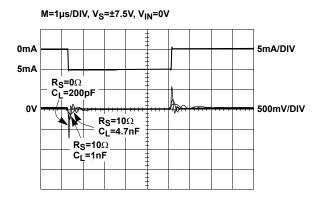
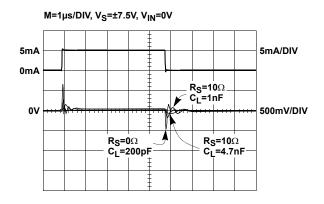
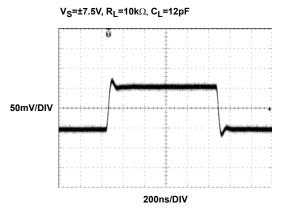


FIGURE 12. TRANSIENT LOAD REGULATION - SOURCING (BUFFER)

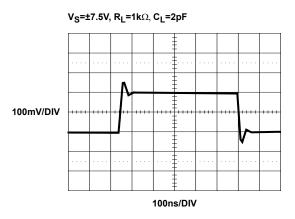
## Typical Performance Curves (Continued)



# FIGURE 13. TRANSIENT LOAD REGULATION - SINKING (BUFFER)

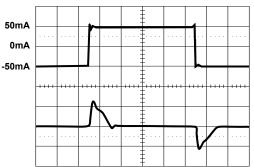




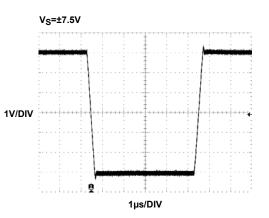


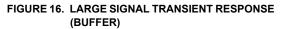


 $\textbf{V}_{\mbox{S}} \mbox{=} \mbox{t7.5V}, \mbox{R}_{\mbox{L}} \mbox{=} \mbox{200} \Omega, \mbox{C}_{\mbox{L}} \mbox{=} \mbox{150pF}$ 



### FIGURE 14. TRANSIENT LOAD REGULATION (VCOM)





1

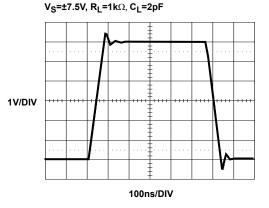


FIGURE 18. LARGE SIGNAL TRANSIENT REPONSE (VCOM)

### Typical Performance Curves (Continued)

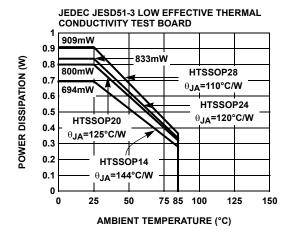


FIGURE 19. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

### Description of Operation and Application Information

### **Product Description**

The EL5524, EL5624, EL5724, and EL5824 are fabricated using a high voltage CMOS process. They exhibit rail to rail input and output capability and have very low power consumption. When driving a load of 10K and 12pF, the buffers have a -3dB bandwidth of 12MHz and exhibit 18V/µs slew rate. The V<sub>COM</sub> amplifier has a -3dB bandwidth of 35MHz and exhibit 80V/µs slew rate.

### Input, Output, and Supply Voltage Range

The EL5524, EL5624, EL5724, and EL5824 are specified with a single nominal supply voltage from 5V to 15V or a split supply with its total range from 5V to 15V. Correct operation is guaranteed for a supply range from 4.5V to 16.5V.

The input common-mode voltage range of the EL5524, EL5624, EL5724, and EL5824 extends 500mV beyond the supply rails. The output swings of the buffers and V<sub>COM</sub> amplifier typically extend to within 100mV of the positive and negative supply rails with load currents of 5mA. Decreasing load currents will extend the output voltage even closer to each supply rails.

### **Output Phase Reversal**

The EL5524, EL5624, EL5724, and EL5824 are immune to phase reversal as long as the input voltage is limited from V<sub>S</sub>--0.5V to V<sub>S</sub>++0.5V. Although the device's output will not change phase, the input's overvoltage should be avoided. If an input voltage exceeds supply voltage by more than 0.6V, electrostatic protection diode placed in the input stage of the device begin to conduct and overvoltage damage could occur.

9

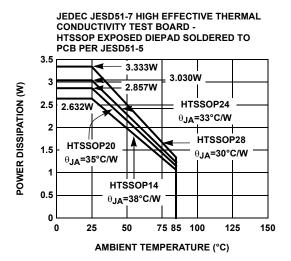


FIGURE 20. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

# Choice of Feedback Resistor and Gain Bandwidth Product for V<sub>COM</sub> Amplifier

For applications that require a gain of +1, no feedback resistor is required. Just short the output pin to the inverting input pin. For gains greater than +1, the feedback resistor forms a pole with the parasitic capacitance at the inverting input. As this pole becomes smaller, the amplifier's phase margin is reduced. This causes ringing in the time domain and peaking in the frequency domain. Therefore, R<sub>F</sub> has some maximum value that should not be exceeded for optimum performance. If a large value of R<sub>F</sub> must be used, a small capacitor in the few Pico farad range in parallel with R<sub>F</sub> can help to reduce the ringing and peaking at the expense of reducing the bandwidth.

As far as the output stage of the amplifier is concerned, the output stage is also a gain stage with the load.  $R_F$  and  $R_G$  appear in parallel with  $R_L$  for gains other than +1. As this combination gets smaller, the bandwidth falls off. Consequently,  $R_F$  also has a minimum value that should not be exceeded for optimum performance. For gain of +1,  $R_F$  = 0 is optimum. For the gains other than +1, optimum response is obtained with  $R_F$  between  $1k\Omega$  to  $5k\Omega$ .

The V<sub>COM</sub> amplifier has a gain bandwidth product of 20MHz. For gains  $\geq$ 5, its bandwidth can be predicted by the following equation:

 $Gain \times BW = 20MHz$ 

### **Output Drive Capability**

The EL5524, EL5624, EL5724, and EL5824 do not have internal short-circuit protection circuitry. The buffers will limit the short circuit current to  $\pm$ 120mA and the V<sub>COM</sub> amplifier

will limit the short circuit current to  $\pm 200$ mA if the outputs are directly shorted to the positive or the negative supply. If the output is shorted indefinitely, the power dissipation could easily increase such that the part will be destroyed. Maximum reliability is maintained if the output continuous current never exceeds  $\pm 30$ mA for the buffers and  $\pm 60$ mA for the V<sub>COM</sub> amplifier. These limits are set by the design of the internal metal interconnections.

### The Unused Buffers

It is recommended that any unused buffers should have their inputs tied to ground plane.

### **Power Dissipation**

With the high-output drive capability of the EL5524, EL5624, EL5724, and EL5824, it is possible to exceed the 125°C "absolute-maximum junction temperature" under certain load current conditions. Therefore, it is important to calculate the maximum junction temperature for the application to determine if load conditions need to be modified for the buffer to remain in the safe operating area.

The maximum power dissipation allowed in a package is determined according to:

$$\mathsf{P}_{\mathsf{DMAX}} = \frac{\mathsf{T}_{\mathsf{JMAX}} - \mathsf{T}_{\mathsf{AMAX}}}{\Theta_{\mathsf{JA}}}$$

where:

- T<sub>JMAX</sub> = Maximum junction temperature
- TAMAX = Maximum ambient temperature
- θ<sub>JA</sub> = Thermal resistance of the package
- P<sub>DMAX</sub> = Maximum power dissipation in the package

The maximum power dissipation actually produced by an IC is the total quiescent supply current times the total power supply voltage, plus the power in the IC due to the loads, or:

$$\begin{split} & \textbf{P}_{DMAX} = \textbf{V}_{S} \times \textbf{I}_{S} + \boldsymbol{\Sigma}i \times [(\textbf{V}_{S}\textbf{+} - \textbf{V}_{OUT}i) \times \textbf{I}_{LOAD}i] + \\ & (\textbf{V}_{S}\textbf{+} - \textbf{V}_{OUT}) \times \textbf{I}_{LA} \end{split}$$

when sourcing, and:

$$\begin{split} & \mathsf{P}_{\mathsf{DMAX}} = \mathsf{V}_{\mathsf{S}} \times \mathsf{I}_{\mathsf{S}} + \Sigma i \times [(\mathsf{V}_{\mathsf{OUT}}i - \mathsf{V}_{\mathsf{S}}\text{-}) \times \mathsf{I}_{\mathsf{LOAD}}i] + \\ & (\mathsf{V}_{\mathsf{OUT}} - \mathsf{V}_{\mathsf{S}}\text{-}) \times \mathsf{I}_{\mathsf{LA}} \end{split}$$

when sinking.

### where:

- i = 1 to total number of buffers
- V<sub>S</sub> = Total supply voltage of buffer and V<sub>COM</sub>
- I<sub>SMAX</sub> = Total quiescent current
- V<sub>OUT</sub>i = Maximum output voltage of the application
- V<sub>OUT</sub> = Maximum output voltage of V<sub>COM</sub>
- ILOADi = Load current of buffer
- ILA = Load current of V<sub>COM</sub>

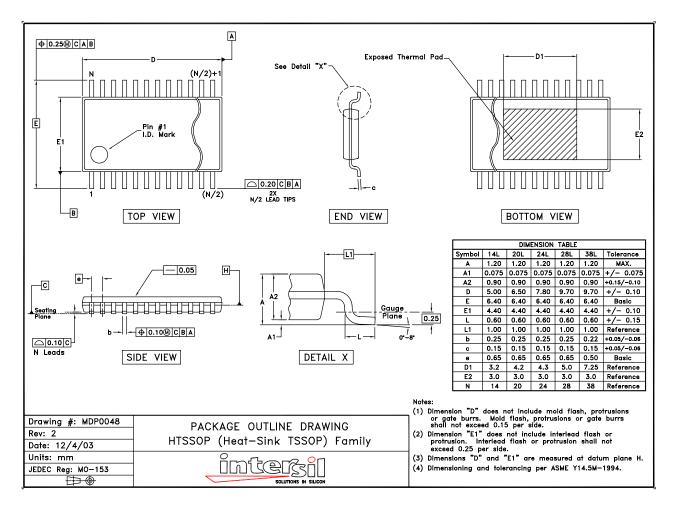
If we set the two  $P_{DMAX}$  equations equal to each other, we can solve for the  $R_{LOAD}$ 's to avoid device overheat. The package power dissipation curves provide a convenient way to see if the device will overheat. The maximum safe power dissipation can be found graphically, based on the package type and the ambient temperature. By using the previous equation, it is a simple matter to see if  $P_{DMAX}$  exceeds the device's power derating curves.

### Power Supply Bypassing and Printed Circuit Board Layout

As with any high frequency device, good printed circuit board layout is necessary for optimum performance. Ground plane construction is highly recommended, lead lengths should be as short as possible, and the power supply pins must be well bypassed to reduce the risk of oscillation. For normal single supply operation, where the V<sub>S</sub>- pin is connected to ground, one 0.1µF ceramic capacitor should be placed from the V<sub>S</sub>+ pin to ground. A 4.7µF tantalum capacitor should then be connected from the V<sub>S</sub>+ pin to ground. One 4.7µF capacitor may be used for multiple devices. This same capacitor combination should be placed at each supply pin to ground if split supplies are to be used.

Important Note: The metal plane used for heat sinking of the device is electrically connected to the negative supply potential ( $V_{S}$ -). If  $V_{S}$ - is tied to ground, the thermal pad can be connected to ground. Otherwise, the thermal pad must be isolated from any other power planes.

# HTSSOP Package Outline Drawing



NOTE: The package drawings shown here may not be the latest versions. For the latest revisions, please refer to the Intersil website at www.intersil.com/design/packages/elantec

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